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Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	6000
Number of Logic Elements/Cells	48000
Total RAM Bits	396288
Number of I/O	500
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-50se-5f672i

Delay Locked Loops (DLL)

In addition to PLLs, the LatticeECP2/M family of devices has two DLLs per device.

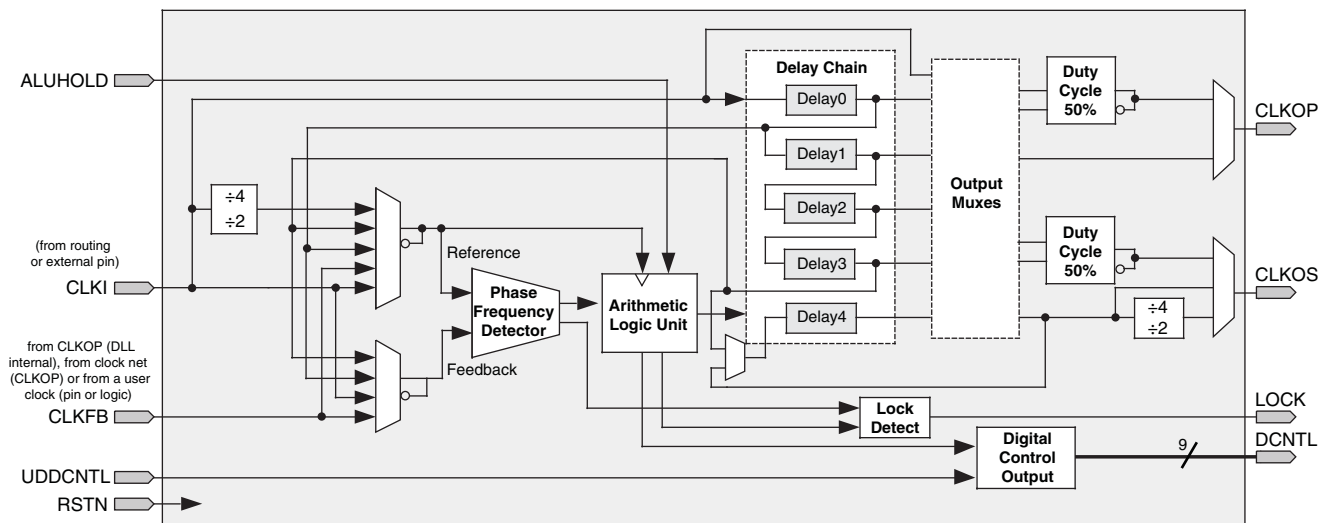
CLKI is the input frequency (generated either from the pin or routing) for the DLL. CLKI feeds into the output muxes block to bypass the DLL, directly to the DELAY CHAIN block and (directly or through divider circuit) to the reference input of the Phase Frequency Detector (PFD) input mux. The reference signal for the PFD can also be generated from the Delay Chain and CLKFB signals. The feedback input to the PFD is generated from the CLKFB pin, CLKI or from tapped signal from the Delay chain.

The PFD produces a binary number proportional to the phase and frequency difference between the reference and feedback signals. This binary output of the PFD is fed into a Arithmetic Logic Unit (ALU). Based on these inputs, the ALU determines the correct digital control codes to send to the delay chain in order to better match the reference and feedback signals. This digital code from the ALU is also transmitted via the Digital Control bus (DCNTL) bus to its associated DLLDELA delay block. The ALUHOLD input allows the user to suspend the ALU output at its current value. The UDDCNTL signal allows the user to latch the current value on the DCNTL bus.

The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. Both the CLKOS and CLKOP outputs are available with optional duty cycle correction. Divide by two and divide by four frequencies are available at CLKOS. The LOCK output signal is asserted when the DLL is locked. Figure 2-6 shows the DLL block diagram and Table 2-5 provides a description of the DLL inputs and outputs.

The user can configure the DLL for many common functions such as time reference delay mode and clock injection removal mode. Lattice provides primitives in its design tools for these functions. For more information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-6. Delay Locked Loop Diagram (DLL)

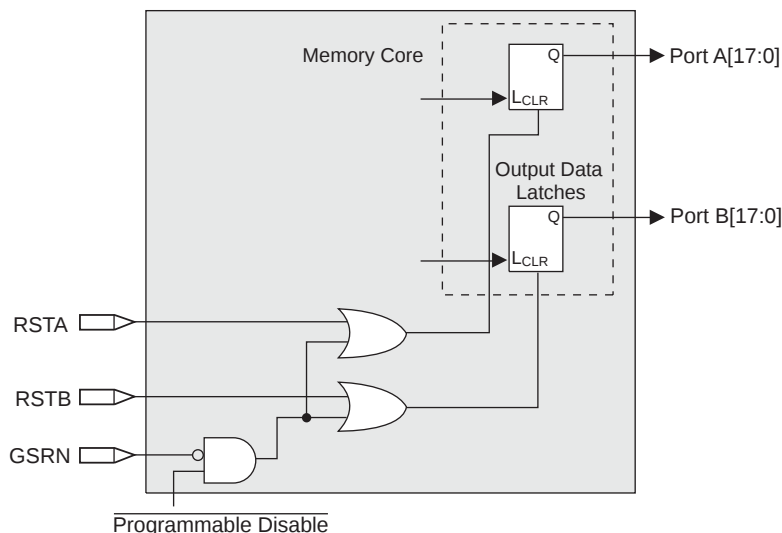


2. Write Through – A copy of the input data appears at the output of the same port during a write cycle. This mode is supported for all data widths.

Memory Core Reset

The memory array in the EBR utilizes latches at the A and B output ports. These latches can be reset asynchronously or synchronously. RSTA and RSTB are local signals, which reset the output latches associated with Port A and Port B, respectively. The Global Reset (GSRN) signal resets both ports. The output data latches and associated resets for both ports are as shown in Figure 2-20.

Figure 2-20. Memory Core Reset

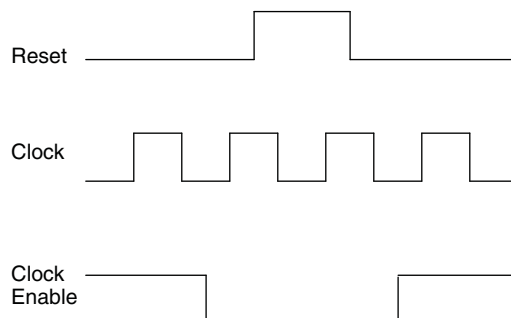


For further information about the sysMEM EBR block, please see the the list of additional technical documentation at the end of this data sheet.

EBR Asynchronous Reset

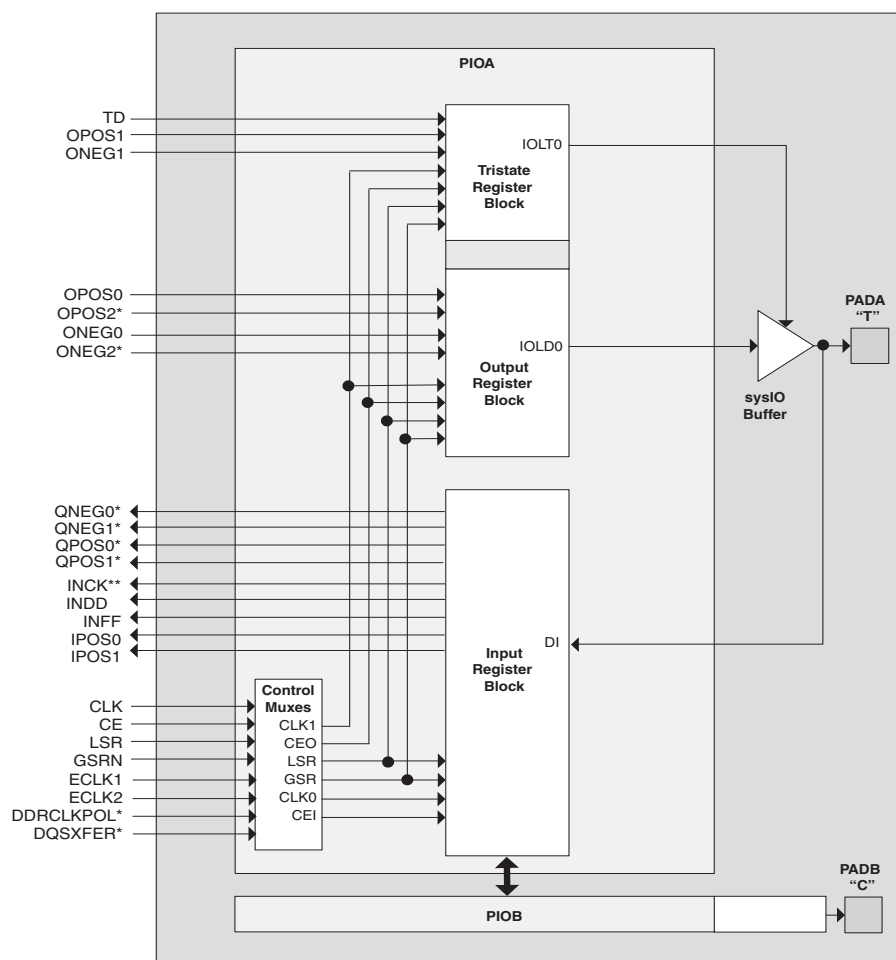
EBR asynchronous reset or GSR (if used) can only be applied if all clock enables are low for a clock cycle before the reset is applied and released a clock cycle after the reset is released, as shown in Figure 2-21. The GSR input to the EBR is always asynchronous.

Figure 2-21. EBR Asynchronous Reset (Including GSR) Timing Diagram



If all clock enables remain enabled, the EBR asynchronous reset or GSR may only be applied and released after the EBR read and write clock inputs are in a steady state condition for a minimum of $1/f_{MAX}$ (EBR clock). The reset release must adhere to the EBR synchronous reset setup time before the next active read or write clock edge.

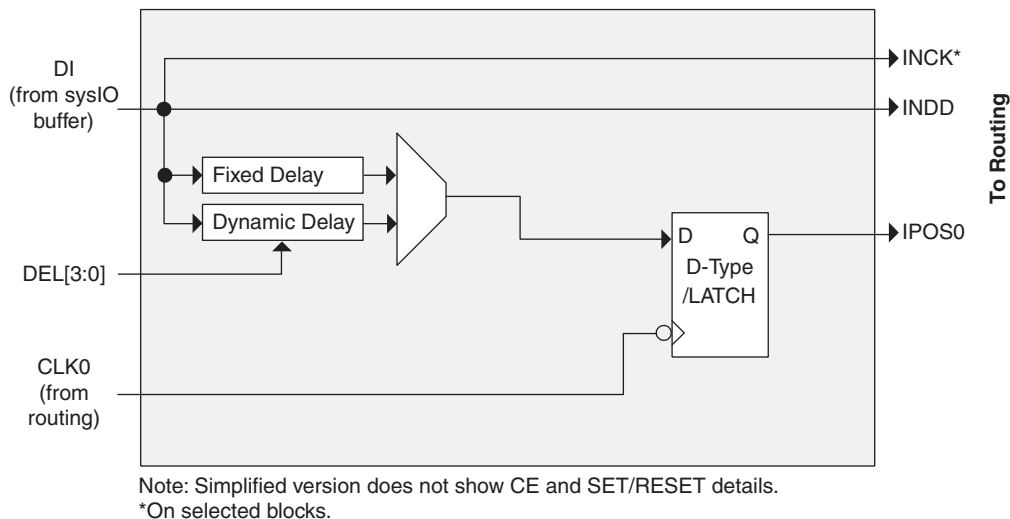
Figure 2-28. PIC Diagram



*Signals are available on left/right/bottom edges only.
** Selected blocks.

Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as "T" and "C") as shown in Figure 2-28. The PAD Labels "T" and "C" distinguish the two PIOs. Approximately 50% of the PIO pairs on the left and right edges of the device can be configured as true LVDS outputs. All I/O pairs can operate as inputs.

Figure 2-30. Input Register Block Top Edge



Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the sysI/O buffers. The blocks on the PIOs on the left, right and bottom contain a register for SDR operation that is combined with an additional latch for DDR operation. Figure 2-31 shows the diagram of the Output Register Block for PIOs on the left, right and the bottom edges. Figure 2-32 shows the diagram of the Output Register Block for PIOs on the top edge of the device.

In SDR mode, ONEG0 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured as a D-type or latch. In DDR mode, ONEG0 and OPOS0 are fed into registers on the positive edge of the clock. Then at the next clock cycle this registered OPOS0 is latched. A multiplexer running off the same clock selects the correct register for feeding to the output (D0).

By combining the output blocks of the complementary PIOs and sharing some registers from input blocks, a gearbox function can be implemented, that takes four data streams: ONEG0A, ONEG1A, ONEG1B and ONEG1B. Figure 2-32 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

sysI/O Differential Electrical Characteristics

LVDS

Over Recommended Operating Conditions

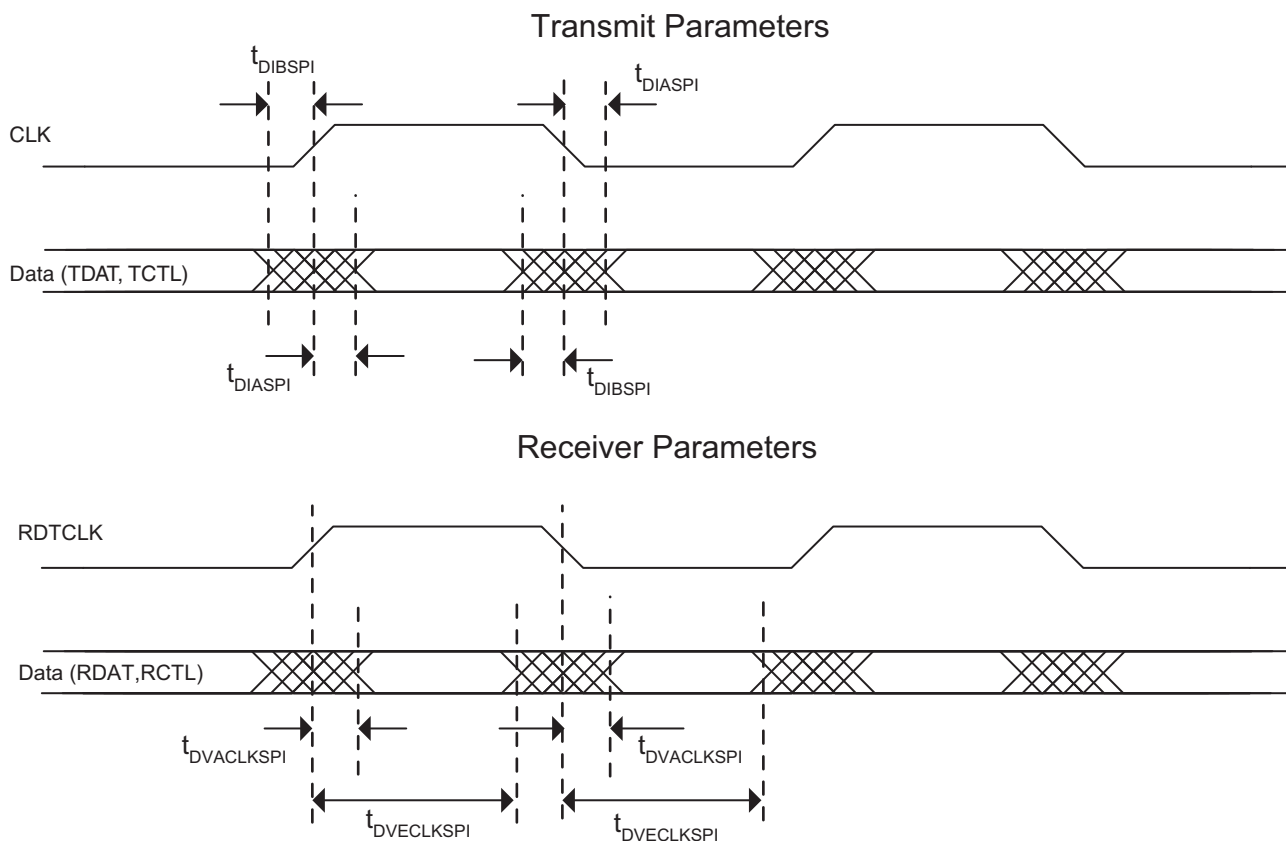
Parameter	Description	Test Conditions	Min.	Typ.	Max.	Units
$V_{INP} V_{INM}$	Input Voltage		0	—	2.4	V
V_{CM}	Input Common Mode Voltage	Half the Sum of the Two Inputs	0.05	—	2.35	V
V_{THD}	Differential Input Threshold	Difference Between the Two Inputs	+/-100	—	—	mV
I_{IN}	Input Current	Power On or Power Off	—	—	+/-10	μ A
V_{OH}	Output High Voltage for V_{OP} or V_{OM}	$R_T = 100$ Ohm	—	1.38	1.60	V
V_{OL}	Output Low Voltage for V_{OP} or V_{OM}	$R_T = 100$ Ohm	0.9V	1.03	—	V
V_{OD}	Output Voltage Differential	$(V_{OP} - V_{OM})$, $R_T = 100$ Ohm	250	350	450	mV
ΔV_{OD}	Change in V_{OD} Between High and Low		—	—	50	mV
V_{OS}	Output Voltage Offset	$(V_{OP} + V_{OM})/2$, $R_T = 100$ Ohm	1.125	1.20	1.375	V
ΔV_{OS}	Change in V_{OS} Between H and L		—	—	50	mV
I_{SA}	Output Short Circuit Current	$V_{OD} = 0V$ Driver Outputs Shorted to Ground	—	—	24	mA
I_{SAB}	Output Short Circuit Current	$V_{OD} = 0V$ Driver Outputs Shorted to Each Other	—	—	12	mA

Differential HSTL and SSTL

Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

For further information about LVPECL, RSDS, MLVDS, BLVDS and other differential interfaces please see the list of additional technical information at the end of this data sheet.

Figure 3-6. SPI4.2 Parameters



LatticeECP2/M Family Timing Adders^{1, 2, 3} (Continued)
Over Recommended Operating Conditions

Buffer Type	Description	-7	-6	-5	Units
LVC MOS25_4mA	LVC MOS 2.5 4mA drive, slow slew rate	2.18	2.26	2.33	ns
LVC MOS25_8mA	LVC MOS 2.5 8mA drive, slow slew rate	2.19	2.35	2.51	ns
LVC MOS25_12mA	LVC MOS 2.5 12mA drive, slow slew rate	1.50	1.66	1.82	ns
LVC MOS25_16mA	LVC MOS 2.5 16mA drive, slow slew rate	1.60	1.59	1.58	ns
LVC MOS25_20mA	LVC MOS 2.5 20mA drive, slow slew rate	1.43	1.39	1.34	ns
LVC MOS18_4mA	LVC MOS 1.8 4mA drive, slow slew rate	2.22	2.27	2.32	ns
LVC MOS18_8mA	LVC MOS 1.8 8mA drive, slow slew rate	1.93	2.08	2.23	ns
LVC MOS18_12mA	LVC MOS 1.8 12mA drive, slow slew rate	1.43	1.51	1.58	ns
LVC MOS18_16mA	LVC MOS 1.8 16mA drive, slow slew rate	1.47	1.46	1.45	ns
LVC MOS15_4mA	LVC MOS 1.5 4mA drive, slow slew rate	2.32	2.38	2.43	ns
LVC MOS15_8mA	LVC MOS 1.5 8mA drive, slow slew rate	1.84	1.98	2.12	ns
LVC MOS12_2mA	LVC MOS 1.2 2mA drive, slow slew rate	2.52	2.63	2.74	ns
LVC MOS12_6mA	LVC MOS 1.2 6mA drive, slow slew rate	1.69	1.83	1.96	ns
PCI33	PCI33	0.04	0.04	0.04	ns

1. Timing Adders are characterized but not tested on every device.

2. LVC MOS timing measured with the load specified in Switching Test Condition table.

3. All other standards tested according to the appropriate specifications.

4. These timing adders are measured with the recommended resistor values.

Timing v.A 0.11

PICs and DDR Data (DQ) Pins Associated with the DDR Strobe (DQS) Pin

PICs Associated with DQS Strobe	PIO Within PIC	DDR Strobe (DQS) and Data (DQ) Pins
For Left and Right Edges of the Device		
P[Edge] [n-4]	A	DQ
	B	DQ
P[Edge] [n-3]	A	DQ
	B	DQ
P[Edge] [n-2]	A	DQ
	B	DQ
P[Edge] [n-1]	A	DQ
	B	DQ
P[Edge] [n]	A	[Edge]DQSn
	B	DQ
P[Edge] [n+1]	A	DQ
	B	DQ
P[Edge] [n+2]	A	DQ
	B	DQ
P[Edge] [n+3]	A	DQ
	B	DQ
For Bottom Edge of the Device		
P[Edge] [n-4]	A	DQ
	B	DQ
P[Edge] [n-3]	A	DQ
	B	DQ
P[Edge] [n-2]	A	DQ
	B	DQ
P[Edge] [n-1]	A	DQ
	B	DQ
P[Edge] [n]	A	[Edge]DQSn
	B	DQ
P[Edge] [n+1]	A	DQ
	B	DQ
P[Edge] [n+2]	A	DQ
	B	DQ
P[Edge] [n+3]	A	DQ
	B	DQ
P[Edge] [n+4]	A	DQ
	B	DQ

Notes:

1. "n" is a row PIC number.
2. The DDR interface is designed for memories that support one DQS strobe up to 15 bits of data for the left and right edges and up to 17 bits of data for the bottom edge. In some packages, all the potential DDR data (DQ) pins may not be available. PIC numbering definitions are provided in the "Signal Names" column of the Signal Descriptions table.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N14	CFG1	8			CFG1	8		
N13	PROGRAMN	8			PROGRAMN	8		
N15	CFG0	8			CFG0	8		
P15	PR30B	8	WRITEN	C	PR30B	8	WRITEN	C
L12	INITN	8			INITN	8		
N16	PR29B	8	CSN	C	PR29B	8	CSN	C
GND	GNDIO8	-			GNDIO8	-		
R14	CCLK	8			CCLK	8		
P14	PR30A	8	CS1N	T	PR30A	8	CS1N	T
M13	DONE	8			DONE	8		
R16	PR28B	8	D1	C	PR28B	8	D1	C
VCCIO	VCCIO8	8			VCCIO8	8		
M16	PR29A	8	D0/SPIFASTN	T	PR29A	8	D0/SPIFASTN	T
P16	PR28A	8	D2	T	PR28A	8	D2	T
L15	PR27B	8	D3	C	PR27B	8	D3	C
GND	GNDIO8	-			GNDIO8	-		
L14	PR26A	8	D6	T	PR26A	8	D6	T
L16	PR27A	8	D4	T	PR27A	8	D4	T
L10	PR25B	8	D7/SPID0	C	PR25B	8	D7/SPID0	C
L13	PR26B	8	D5	C	PR26B	8	D5	C
VCCIO	VCCIO8	8			VCCIO8	8		
K11	PR25A	8	DI/CSSPI0N	T	PR25A	8	DI/CSSPI0N	T
K14	PR24B	8	DOU/CSON	C	PR24B	8	DOU/CSON	C
K13	PR24A	8	BUSY/SISPI	T	PR24A	8	BUSY/SISPI	T
GND	GNDIO8	-			GNDIO8	-		
K15	PR21B	3	RLM0_GPLL_C_FB_A	C	PR21B	3	RLM0_GPLL_C_FB_A	C
VCCIO	VCCIO3	3			VCCIO3	3		
K16	PR21A	3	RLM0_GPLL_T_FB_A	T	PR21A	3	RLM0_GPLL_T_FB_A	T
GND	GNDIO3	-			GNDIO3	-		
J16	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*
J15	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*
J14	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
J13	PR18B	3	RLM0_GDLL_C_FB_A	C	PR18B	3	RLM0_GDLL_C_FB_A	C
J12	PR18A	3	RLM0_GDLL_T_FB_A	T	PR18A	3	RLM0_GDLL_T_FB_A	T
H12	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*
GND	GNDIO3	-			GNDIO3	-		
H13	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*
H15	PR16B	3	VREF2_3	C	PR16B	3	VREF2_3	C
VCCIO	VCCIO3	3			VCCIO3	3		
H16	PR16A	3	VREF1_3	T	PR16A	3	VREF1_3	T
H11	PR15B	3	PCLKC3_0	C (LVDS)*	PR15B	3	PCLKC3_0	C (LVDS)*
J11	PR15A	3	PCLKT3_0	T (LVDS)*	PR15A	3	PCLKT3_0	T (LVDS)*
G16	PR13B	2	PCLKC2_0/RDQ10	C	PR13B	2	PCLKC2_0/RDQ10	C
GND	GNDIO2	-			GNDIO2	-		
G15	PR13A	2	PCLKT2_0/RDQ10	T	PR13A	2	PCLKT2_0/RDQ10	T

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
-	-	-			GNDIO1	1		
-	-	-			VCCIO	1		
D10	PT19B	1		C	PT37B	1		C
C10	PT19A	1		T	PT37A	1		T
GND	GNDIO1	-			GNDIO1	-		
B10	PT18B	1		C	PT36B	1		C
A9	PT17B	1		C	PT35B	1		C
A10	PT18A	1		T	PT36A	1		T
B9	PT17A	1		T	PT35A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A8	PT16B	1		C	PT34B	1		C
D9	PT15B	1		C	PT33B	1		C
B8	PT16A	1		T	PT34A	1		T
C9	PT15A	1		T	PT33A	1		T
GND	GNDIO1	-			GNDIO1	-		
B7	PT14B	1		C	PT32B	1		C
E9	PT13B	1		C	PT31B	1		C
A7	PT14A	1		T	PT32A	1		T
D8	PT13A	1		T	PT31A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A6	PT12B	1	PCLKC1_0	C	PT30B	1	PCLKC1_0	C
B6	PT12A	1	PCLKT1_0	T	PT30A	1	PCLKT1_0	T
E6	XRES	-			XRES	1		
F8	PT10B	0	PCLKC0_0	C	PT28B	0	PCLKC0_0	C
GND	GNDIO0	-			GNDIO0	-		
E8	PT10A	0	PCLKT0_0	T	PT28A	0	PCLKT0_0	T
A5	PT9B	0		C	PT27B	0		C
A3	PT8B	0		C	PT26B	0		C
A4	PT9A	0		T	PT27A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
B3	PT8A	0		T	PT26A	0		T
A2	PT7B	0		C	PT25B	0		C
C7	PT6B	0		C	PT24B	0		C
B2	PT7A	0		T	PT25A	0		T
D7	PT6A	0		T	PT24A	0		T
D6	PT5B	0		C	PT23B	0		C
GND	GNDIO0	-			GNDIO0	-		
F7	PT4B	0		C	PT22B	0		C
C6	PT5A	0		T	PT23A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
F6	PT4A	0		T	PT22A	0		T
C4	PT3B	0		C	PT21B	0		C
B4	PT3A	0		T	PT21A	0		T
-	-	-			GNDIO0	0		
-	-	-			VCCIO	0		

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C2	PT3A	0		T	PT3A	0		T	
J10	VCC	-			VCC	-			
J11	VCC	-			VCC	-			
J12	VCC	-			VCC	-			
J13	VCC	-			VCC	-			
K14	VCC	-			VCC	-			
K9	VCC	-			VCC	-			
L14	VCC	-			VCC	-			
L9	VCC	-			VCC	-			
M14	VCC	-			VCC	-			
M9	VCC	-			VCC	-			
N14	VCC	-			VCC	-			
N9	VCC	-			VCC	-			
P10	VCC	-			VCC	-			
P11	VCC	-			VCC	-			
P12	VCC	-			VCC	-			
P13	VCC	-			VCC	-			
G10	VCCIO0	0			VCCIO0	0			
G9	VCCIO0	0			VCCIO0	0			
H9	VCCIO0	0			VCCIO0	0			
H8	VCCIO0	0			VCCIO0	0			
G11	VCCIO1	1			VCCIO1	1			
G12	VCCIO1	1			VCCIO1	1			
G13	VCCIO1	1			VCCIO1	1			
G14	VCCIO1	1			VCCIO1	1			
H14	VCCIO2	2			VCCIO2	2			
H15	VCCIO2	2			VCCIO2	2			
J15	VCCIO2	2			VCCIO2	2			
K16	VCCIO2	2			VCCIO2	2			
L16	VCCIO3	3			VCCIO3	3			
M16	VCCIO3	3			VCCIO3	3			
N16	VCCIO3	3			VCCIO3	3			
P16	VCCIO3	3			VCCIO3	3			
R14	VCCIO4	4			VCCIO4	4			
T12	VCCIO4	4			VCCIO4	4			
T13	VCCIO4	4			VCCIO4	4			
T14	VCCIO4	4			VCCIO4	4			
R9	VCCIO5	5			VCCIO5	5			
T10	VCCIO5	5			VCCIO5	5			
T11	VCCIO5	5			VCCIO5	5			
T9	VCCIO5	5			VCCIO5	5			
N7	VCCIO6	6			VCCIO6	6			
P7	VCCIO6	6			VCCIO6	6			
P8	VCCIO6	6			VCCIO6	6			

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L23	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M18	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R18	VCCIO3	3			VCCIO3	3		
T23	VCCIO3	3			VCCIO3	3		
V20	VCCIO3	3			VCCIO3	3		
AC16	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V15	VCCIO4	4			VCCIO4	4		
Y18	VCCIO4	4			VCCIO4	4		
AC11	VCCIO5	5			VCCIO5	5		
AC6	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
V12	VCCIO5	5			VCCIO5	5		
Y9	VCCIO5	5			VCCIO5	5		
AA4	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R9	VCCIO6	6			VCCIO6	6		
T4	VCCIO6	6			VCCIO6	6		
V7	VCCIO6	6			VCCIO6	6		
F4	VCCIO7	7			VCCIO7	7		
J7	VCCIO7	7			VCCIO7	7		
L4	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M9	VCCIO7	7			VCCIO7	7		
AE25	VCCIO8	8			VCCIO8	8		
V18	VCCIO8	8			VCCIO8	8		
J10	VCCAUX	-			VCCAUX	-		
J11	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
J17	VCCAUX	-			VCCAUX	-		
K18	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
U18	VCCAUX	-			VCCAUX	-		
U9	VCCAUX	-			VCCAUX	-		
V10	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
V17	VCCAUX	-			VCCAUX	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C5	PT11B	0		C
D5	PT11A	0		T
E9	PT10B	0		C
G9	PT10A	0		T
GND	GNDIO0	-		
B10	PT9B	0		C
A10	PT9A	0		T
D9	PT8B	0		C
C9	PT8A	0		T
VCCIO	VCCIO0	0		
F9	PT7B	0		C
H9	PT7A	0		T
B9	PT6B	0		C
A9	PT6A	0		T
GND	GNDIO0	-		
E8	PT5B	0		C
G8	PT5A	0		T
A8	PT4B	0		C
B8	PT4A	0		T
VCCIO	VCCIO0	0		
F8	PT3B	0		C
F7	PT3A	0		T
J10	PT2B	0	VREF2_0	C
J9	PT2A	0	VREF1_0	T
AA11	VCC	-		
AA20	VCC	-		
K11	VCC	-		
K21	VCC	-		
K22	VCC	-		
L11	VCC	-		
L12	VCC	-		
L13	VCC	-		
L18	VCC	-		
L19	VCC	-		
L20	VCC	-		
M11	VCC	-		
M20	VCC	-		
N11	VCC	-		
N20	VCC	-		
V11	VCC	-		
V20	VCC	-		
W11	VCC	-		
W20	VCC	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A3	GND	-			GND	-		
A9	GND	-			GND	-		
B12	GND	-			GND	-		
B6	GND	-			GND	-		
E15	GND	-			GND	-		
E2	GND	-			GND	-		
H14	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J3	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
M15	GND	-			GND	-		
M2	GND	-			GND	-		
P9	GND	-			GND	-		
R12	GND	-			GND	-		
R5	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
D10	NC	-			NC	-		
D11	NC	-			NC	-		
D12	NC	-			NC	-		
D13	NC	-			NC	-		
D14	NC	-			NC	-		
D4	NC	-			NC	-		
D5	NC	-			NC	-		
D6	NC	-			NC	-		
D7	NC	-			NC	-		
E11	NC	-			NC	-		
E6	NC	-			NC	-		
E8	NC	-			NC	-		
E9	NC	-			NC	-		
F10	NC	-			NC	-		
F7	NC	-			NC	-		
F8	NC	-			NC	-		
F9	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
K19	PR16A	2	RDQ15	T	PR19A	2		T	
G24	PR15B	2	RDQ15	C (LVDS)*	PR18B	2		C*	
G23	PR15A	2	RDQS15	T (LVDS)*	PR18A	2		T*	
GNDIO	GNDIO2	-			GNDIO2	-			
J18	PR14B	2	RDQ15	C	PR14B	2		C	
F22	PR14A	2	RDQ15	T	PR14A	2		T	
-	-	-			VCCIO2	2			
F23	PR13B	2	RDQ15	C (LVDS)*	PR13B	2		C*	
F24	PR13A	2	RDQ15	T (LVDS)*	PR13A	2		T*	
VCCIO	VCCIO2	2			-	-			
H20	PR12B	2	RUM0_SPLLC_FB_A/RDQ15	C	PR12B	2	RUM0_SPLLC_FB_A	C	
-	-	-			GNDIO2	-			
F21	PR12A	2	RUM0_SPLLT_FB_A/RDQ15	T	PR12A	2	RUM0_SPLLT_FB_A	T	
G26	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A	C*	
F26	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A	T*	
-	-	-			VCCIO2	2			
E24	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C	
GNDIO	GNDIO2	-			GNDIO2	-			
E23	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T	
VCCIO	VCCIO4	4			VCCIO2	2			
H19	XRES	-			XRES	-			
C25	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12			
A24	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T	
B25	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12			
B24	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C	
C22	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12			
A21	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T	
A22	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12			
B21	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C	
C21	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12			
B20	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C	
C20	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12			
A20	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T	
C24	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12			
B23	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C	
C23	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12			
A23	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T	
B19	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12			
E19	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C	
D19	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T	
C19	URC_SQ_VCCP	12			URC_SQ_VCCP	12			
A15	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T	

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L16	GND	-			GND	-			
L17	GND	-			GND	-			
L2	GND	-			GND	-			
L20	GND	-			GND	-			
L25	GND	-			GND	-			
L7	GND	-			GND	-			
M13	GND	-			GND	-			
M14	GND	-			GND	-			
N10	GND	-			GND	-			
N12	GND	-			GND	-			
N13	GND	-			GND	-			
N14	GND	-			GND	-			
N15	GND	-			GND	-			
N17	GND	-			GND	-			
P10	GND	-			GND	-			
P12	GND	-			GND	-			
P13	GND	-			GND	-			
P14	GND	-			GND	-			
P15	GND	-			GND	-			
P17	GND	-			GND	-			
R13	GND	-			GND	-			
R14	GND	-			GND	-			
T10	GND	-			GND	-			
T11	GND	-			GND	-			
T16	GND	-			GND	-			
T17	GND	-			GND	-			
T2	GND	-			GND	-			
T20	GND	-			GND	-			
T25	GND	-			GND	-			
T7	GND	-			GND	-			
U11	GND	-			GND	-			
U13	GND	-			GND	-			
U14	GND	-			GND	-			
U16	GND	-			GND	-			
V22	GND	-			GND	-			
V5	GND	-			GND	-			
Y11	GND	-			GND	-			
Y16	GND	-			GND	-			
AB3	NC	-			NC	-			
AB4	NC	-			NC	-			
AC1	NC	-			NC	-			
AC2	NC	-			NC	-			
B4	NC	-			NC	-			
B5	NC	-			NC	-			
C26	NC	-			NC	-			
D20	NC	-			NC	-			
D21	NC	-			NC	-			
D22	NC	-			NC	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
E13	PT28A	0		T	PT37A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
GNDIO	GNDIO0	-			GNDIO0	-			
J12	PT5B	0		C	PT31B	0		C	
GNDIO	GNDIO0	-			-	-			
VCCIO	VCCIO0	0			VCCIO0	0			
H10	PT5A	0		T	PT31A	0		T	
E12	PT4B	0		C	PT30B	0		C	
D11	PT4A	0		T	PT30A	0		T	
H11	PT3B	0		C	PT29B	0		C	
F11	PT3A	0		T	PT29A	0		T	
C13	VCC	-			ULC_SQ_VCCR0	11			
A12	PT19A	0		T	ULC_SQ_HDINP0	11		T	
B13	NC	-			ULC_SQ_VCCIB0	11			
B12	PT19B	0		C	ULC_SQ_HDINN0	11		C	
C10	VCC	-			ULC_SQ_VCCTX0	11			
A9	PT17A	0		T	ULC_SQ_HDOUTP0	11		T	
A10	NC	-			ULC_SQ_VCCOB0	11			
B9	PT17B	0		C	ULC_SQ_HDOUTN0	11		C	
C9	VCC	-			ULC_SQ_VCCTX1	11			
B8	PT18B	0		C	ULC_SQ_HDOUTN1	11		C	
C8	NC	-			ULC_SQ_VCCOB1	11			
A8	PT18A	0		T	ULC_SQ_HDOUTP1	11		T	
C12	VCC	-			ULC_SQ_VCCR1	11			
B11	PT16B	0		C	ULC_SQ_HDINN1	11		C	
C11	NC	-			ULC_SQ_VCCIB1	11			
A11	PT16A	0		T	ULC_SQ_HDINP1	11		T	
B7	VCCAUX	-			ULC_SQ_VCCAUX33	11			
E7	PT15B	0		C	ULC_SQ_REFCLKN	11		C	
D7	PT15A	0		T	ULC_SQ_REFCLKP	11		T	
C7	VCC	-			ULC_SQ_VCCP	11			
A3	PT12A	0		T	ULC_SQ_HDINP2	11		T	
C3	NC	-			ULC_SQ_VCCIB2	11			
B3	PT12B	0		C	ULC_SQ_HDINN2	11		C	
C2	VCC	-			ULC_SQ_VCCR2	11			
A6	PT14A	0		T	ULC_SQ_HDOUTP2	11		T	
C6	NC	-			ULC_SQ_VCCOB2	11			
B6	PT14B	0		C	ULC_SQ_HDOUTN2	11		C	
C5	VCC	-			ULC_SQ_VCCTX2	11			
B5	PT13B	0		C	ULC_SQ_HDOUTN3	11		C	
A4	NC	-			ULC_SQ_VCCOB3	11			
A5	PT13A	0		T	ULC_SQ_HDOUTP3	11		T	
C4	VCC	-			ULC_SQ_VCCTX3	11			
B2	PT11B	0		C	ULC_SQ_HDINN3	11		C	
B1	NC	-			ULC_SQ_VCCIB3	11			
A2	PT11A	0		T	ULC_SQ_HDINP3	11		T	
C1	VCC	-			ULC_SQ_VCCR3	11			
L12	VCC	-			VCC	-			

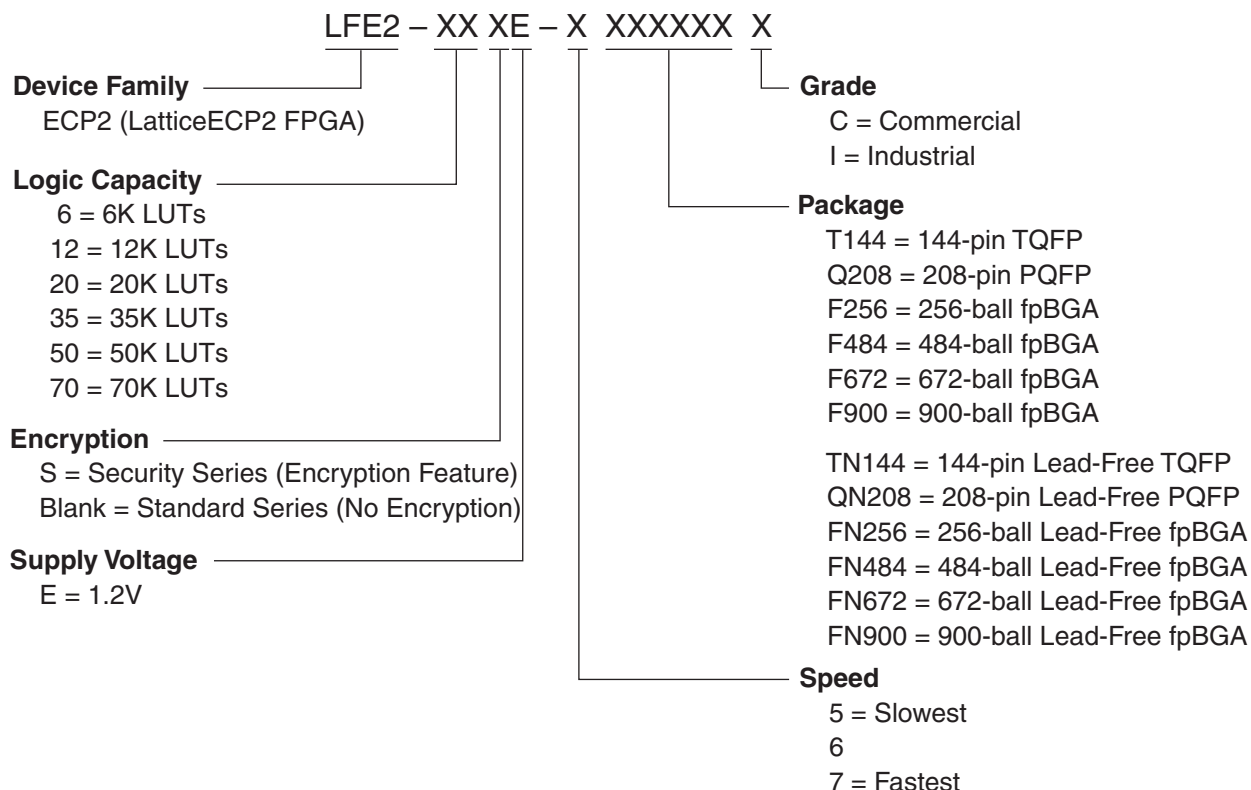
LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AF17	GND	-			GND	-			
AF25	GND	-			GND	-			
AF6	GND	-			GND	-			
AJ10	GND	-			GND	-			
AJ21	GND	-			GND	-			
AJ27	GND	-			GND	-			
AJ4	GND	-			GND	-			
AK1	GND	-			GND	-			
AK13	GND	-			GND	-			
AK18	GND	-			GND	-			
AK24	GND	-			GND	-			
AK30	GND	-			GND	-			
AK7	GND	-			GND	-			
B10	GND	-			GND	-			
B21	GND	-			GND	-			
B27	GND	-			GND	-			
B4	GND	-			GND	-			
D25	GND	-			GND	-			
D6	GND	-			GND	-			
E14	GND	-			GND	-			
E17	GND	-			GND	-			
F22	GND	-			GND	-			
F27	GND	-			GND	-			
F4	GND	-			GND	-			
F9	GND	-			GND	-			
G12	GND	-			GND	-			
G19	GND	-			GND	-			
J24	GND	-			GND	-			
J7	GND	-			GND	-			
K14	GND	-			GND	-			
K15	GND	-			GND	-			
K16	GND	-			GND	-			
K17	GND	-			GND	-			
K27	GND	-			GND	-			
K4	GND	-			GND	-			
L14	GND	-			GND	-			
L15	GND	-			GND	-			
L16	GND	-			GND	-			
L17	GND	-			GND	-			
M23	GND	-			GND	-			
M8	GND	-			GND	-			
N14	GND	-			GND	-			
N15	GND	-			GND	-			
N16	GND	-			GND	-			
N17	GND	-			GND	-			
N27	GND	-			GND	-			
N4	GND	-			GND	-			
P11	GND	-			GND	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M10	VCCIO7	7		
M7	VCCIO7	7		
N10	VCCIO7	7		
N3	VCCIO7	7		
P10	VCCIO7	7		
R6	VCCIO7	7		
AA25	VCCIO8	8		
AD28	VCCIO8	8		
AA10	VCCAUX	-		
AA11	VCCAUX	-		
AA20	VCCAUX	-		
AA21	VCCAUX	-		
K10	VCCAUX	-		
K11	VCCAUX	-		
K20	VCCAUX	-		
K21	VCCAUX	-		
L10	VCCAUX	-		
L11	VCCAUX	-		
L20	VCCAUX	-		
L21	VCCAUX	-		
Y10	VCCAUX	-		
Y11	VCCAUX	-		
Y20	VCCAUX	-		
Y21	VCCAUX	-		
A1	GND	-		
A13	GND	-		
A18	GND	-		
A24	GND	-		
A30	GND	-		
A7	GND	-		
AA14	GND	-		
AA15	GND	-		
AA16	GND	-		
AA17	GND	-		
AA24	GND	-		
AA27	GND	-		
AA4	GND	-		
AB24	GND	-		
AB7	GND	-		
AD12	GND	-		
AD19	GND	-		
AD27	GND	-		
AE22	GND	-		

LatticeECP2 Part Number Description



Ordering Information

Note: LatticeECP2 devices are dual marked. For example, the commercial speed grade LFE2-50E-7F672C is also marked with industrial grade -6I (LFE2-50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:

